

OBSOLETE - PART DISCONTINUED

## Features

- Low Forward Voltage Drop
- Superior Reverse Avalanche Capability
- Patented Super Barrier Rectifier Technology (SBR®)
- Soft, Fast Switching Capability
- +150°C Operating Junction Temperature
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](https://www.diodes.com/quality/product-definitions/) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>**

## Mechanical Data

- Package: X1-DFN1006-2
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: Cathode Dot
- Terminals: Finish - NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (E4)
- Weight: 0.001 grams (Approximate)

X1-DFN1006-2



Top View



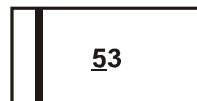
Bottom View

## Ordering Information (Note 4)

Part Number	Package	Packing	
		Qty.	Carrier
SBR05U30LP-7B	X1-DFN1006-2	10,000	Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
  2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
  3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
  4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

## Marking Information



53 = Product Type Marking Code  
-7B: Bar Denotes Cathode Side

**Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>R</sub> RM	30	V
Working Peak Reverse Voltage	V <sub>R</sub> WM		
DC Blocking Voltage	V <sub>R</sub> M		
Average Rectified Output Current (See Fig. 1)	I <sub>O</sub>	500	mA
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>	5	A

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance	R <sub>θ</sub> JS	18	°C/W
Thermal Resistance Junction to Soldering (Note 5)	R <sub>θ</sub> JA	263	
Thermal Resistance Junction to Ambient (Note 6)			
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

**Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop	V <sub>F</sub>	—	0.31	0.36	V	I <sub>F</sub> = 0.1A, T <sub>J</sub> = +25°C
		—	—	0.56		I <sub>F</sub> = 0.5A, T <sub>J</sub> = +25°C
Leakage Current (Note 7)	I <sub>R</sub>	—	—	100	μA	V <sub>R</sub> = 15V, T <sub>J</sub> = +25°C
		—	—	200		V <sub>R</sub> = 30V, T <sub>J</sub> = +25°C
		—	0.8	—	mA	V <sub>R</sub> = 30V, T <sub>J</sub> = +85°C

- Notes:
- Theoretical R<sub>θ</sub>JS calculated from the top center of the die straight down to the PCB cathode tab solder junction.
  - FR-4 PCB, 2oz. copper, minimum recommended pad layout per <http://www.diodes.com/package-outlines.html>.
  - Short duration pulse test used to minimize self-heating effect.

**OBSELETE**

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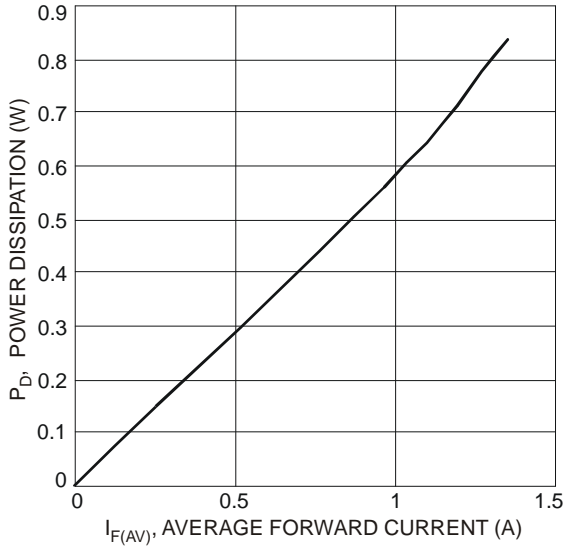


Fig. 1 Forward Power Dissipation

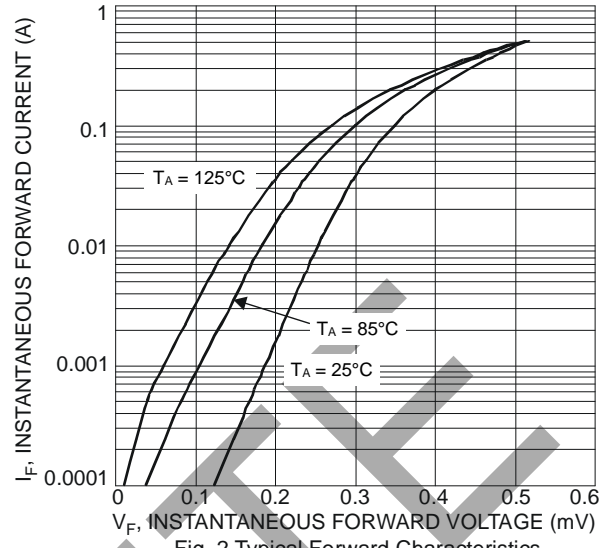


Fig. 2 Typical Forward Characteristics

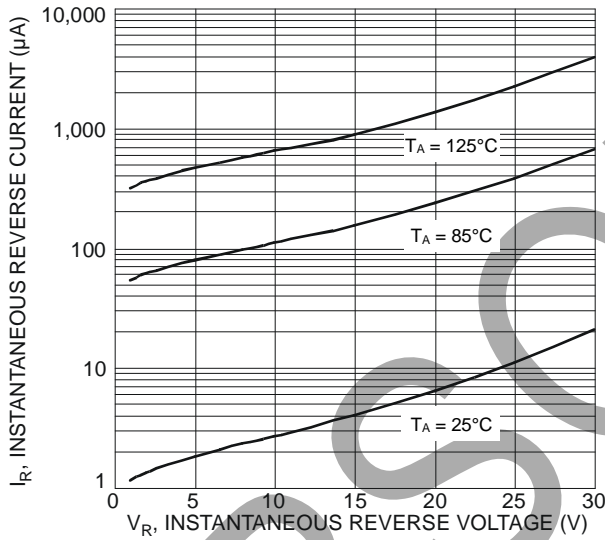


Fig. 3 Typical Reverse Characteristics

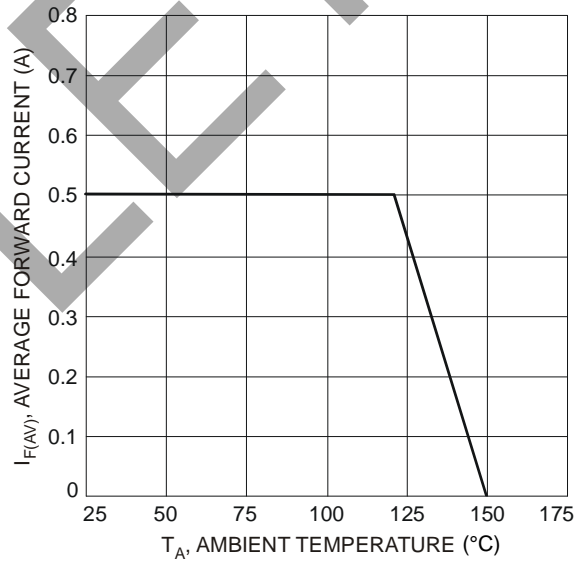
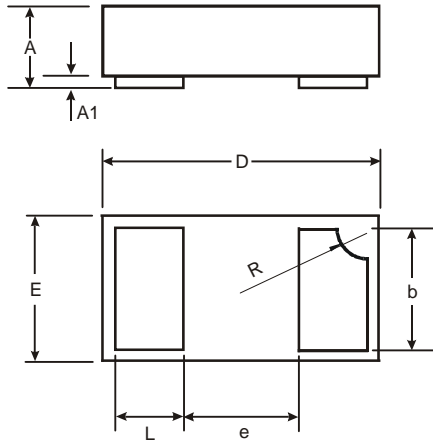


Fig. 4 Forward Current Derating Curve

**Package Outline Dimensions**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**X1-DFN1006-2**

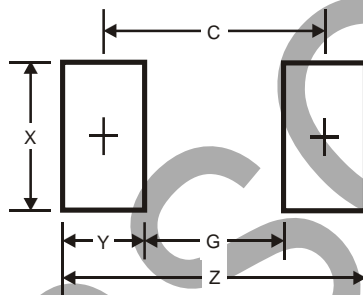


X1-DFN1006-2			
Dim	Min	Max	Typ
A	0.47	0.53	0.50
A1	0	0.05	0.03
b	0.45	0.55	0.50
D	0.95	1.075	1.00
E	0.55	0.675	0.60
e	-	-	0.40
L	0.20	0.30	0.25
R	0.05	0.15	0.10
All Dimensions in mm			

**Suggested Pad Layout**

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

**X1-DFN1006-2**



Dimensions	Value (in mm)
Z	1.1
G	0.3
X	0.7
Y	0.4
C	0.7

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